# 893

FIBER SENSORS

PHOTOELECTRIC SENSORS

LASER SENSORS

MICRO PHOTOELECTRIC SENSORS AREA SENSORS LIGHT CURTAINS / SAFETY PRESSURE / FLOW SENSORS INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS SIMPLE WIRE-SAVING UNITS WIRE-SAVING SYSTEMS MEASUREMENT SENSORS

STATIC ELECTRICITY PREVENTION DEVICES

LASER MARKERS

HUMAN MACHINE

FA COMPONENTS

MACHINE VISION SYSTEMS

UV CURING SYSTEMS

INTERFACES ENERGY CONSUMPTION VISUALIZATION COMPONENTS

PLC

# ED Type Wafer Alignment Sensor ERIES

Related Information

General terms and conditions...... F-7 General precautions ...... P.1458~

Sensor selection guide ...... P.885~

CE



# The use of a safe LED light beam now allows for high precision detection with a resolution of 30 µm 1.181 mil

## No safety measures are required at all

As a safe red LED is used as the light source, there is no need for time-consuming safety measures. The protective covers usually required when using laser beams are not needed, and FDA approval is not required in order to use this sensor in the US.

## Easy installation

This unit is equipped with a one-touch connector to connect the sensor head to the controller. The amount of wiring is therefore minimized, resulting in easy maintenance.



## Low current consumption of 70 mA or less

The HD-T1 series has a maximum current consumption of only 70 mA, for both the sensor head and the controller. The current consumption is almost as low as that of photoelectric sensors.

## High resolution of 30 µm 1.181 mil

Although the HD-T1 series uses a red LED for its light source, it has the same high level of performance as laser sensors, thus enabling high precision detection.

## No need for beam axis alignment

As both the receiver and the emitter are integrated into a single unit, there is no need to perform any troublesome alignment of the beam axis. In addition, as the HD-T1 series can perform its detection function over a broad area - with both a sensing range and a sensing width of 30 mm 1.181 in, this unit can be utilized for sensing wafers of many different sizes.

## Adjustment functions for both span and shift have been incorporated

In addition to the span adjustment function, a convenient shift adjustment function has also been incorporated into the analog output (1 to 5 V). The shift adjustment function allows the analog voltage to be shifted by up to ±0.5 V.



Amount of the light received All light received state

Selection Guide Wafer Detectio Liquid Leak Detection Liquid Level Detection Water Detection Color Mark Detection Hot Melt Glue Detection Ultrasonic Small / Slim Object Detection Obstacle Detection Other Products

M-DW1

FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

LIGHT CURTAINS / SAFETY COMPONENTS

PRESSURE / FLOW SENSORS

INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS

MEASURE-MENT SENSORS STATIC ELECTRICITY PREVENTION DEVICES

LASER MARKERS

PLC

HUMAN MACHINE INTERFACES

ENERGY CONSUMPTION VISUALIZATION COMPONENTS

FA COMPONENTS

MACHINE VISION SYSTEMS

UV CURING SYSTEMS

## APPLICATIONS

Detecting wafer eccentricities or notches



## ORDER GUIDE

#### Sensor head

Appearance	Sensing range	Sensing width	Model No.
	30 mm 1.181 in (fixed) (Note)	30 mm 1.181 in	HD-T1030

Note: The value is in a state that the sensor is mounted on the mounting base at the time of factory shipment.

#### Controller

Appearance	Model No.	Output	Make sure to use the sensor head and the controller together as a set.
	HD-T1C	Analog voltage • Output voltage: 1 to 5 V	

## **SPECIFICATIONS**

#### Sensor head

Model No.	HD-T1030		
icable controller	HD-T1C		
sing width	30 mm 1.181 in (Linearity is specified at 28 mm 1.102 in width.)	Selection Guide	
sing range	30 mm 1.181 in (fixed) (Note 2)	Wafer Detection	
Pollution degree	3 (Industrial environment)	Liquid Lea Detection	
Protection	IP40 (IEC)	Liquid Lev Detection	
Ambient temperature	0 to +40 °C +32 to +104 °F (No dew condensation), Storage: -20 to +55 °C -4 to +131 °F	Vater Detection Color Mart Detection Hot Met Glu Detection 2e Ultrasonic Smal / Sim	
Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH		
Ambient illuminance	Incandescent light: 3,000 fx at the light-receiving face, Fluorescent light: 3,000 fx at the light-receiving face		
Voltage withstandability	1,000 V AC for one min. between all supply terminals connected together and enclosure		
Insulation resistance	20 M $\Omega$ , or more, with 250 V DC megger between all supply terminals connected together and enclosure	Object Detect Obstacle	
Vibration resistance	10 to 150 Hz frequency, 0.75 mm 0.030 in amplitude in X, Y and Z directions for two hours each	Detection	
Shock resistance	tance 490 m/s <sup>2</sup> acceleration (50 G approx.) in X, Y and Z directions for three times each		
ting element	Red LED (Peak emission wavelength: 650 nm 0.026 mil)	M-DW	
eiving element	Photodiode	HD-T1	
erial	Enclosure: PEI, Front cover: Glass, Mounting base: Aluminum		
e	Heat-resistant PVC cable, 0.5 m 1.640 ft long, with a connector at the end		
ght	Net weight: 150 g approx.		
	icable controller sing width sing range Pollution degree Protection Ambient temperature Ambient humidity Ambient illuminance Voltage withstandability Insulation resistance Vibration resistance	HD-T1030           icable controller         HD-T1C           sing width         30 mm 1.181 in (Linearity is specified at 28 mm 1.102 in width.)           sing range         30 mm 1.181 in (fixed) (Note 2)           Pollution degree         3 (Industrial environment)           Protection         IP40 (IEC)           Ambient temperature         0 to +40 °C +32 to +104 °F (No dew condensation), Storage: -20 to +55 °C -4 to +131 °F           Ambient humidity         35 to 85 % RH, Storage: 35 to 85 % RH           Ambient illuminance         Incandescent light: 3,000 tx at the light-receiving face, Fluorescent light: 3,000 tx at the light-receiving face           Voltage withstandability         1,000 V AC for one min. between all supply terminals connected together and enclosure           Insulation resistance         20 MQ, or more, with 250 V DC megger between all supply terminals connected together and enclosure           Vibration resistance         10 to 150 Hz frequency, 0.75 mm 0.030 in amplitude in X, Y and Z directions for two hours each           Shock resistance         490 m/s² acceleration (50 G approx.) in X, Y and Z directions for three times each           ting element         Red LED (Peak emission wavelength: 650 nm 0.026 mil)           eiving element         Enclosure: PEI, Front cover: Glass, Mounting base: Aluminum           e         Heat-resistant PVC cable, 0.5 m 1.640 ft long, with a connector at the end	

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C +68 °F.

2) The value is in a state that the sensor is mounted on the mounting base at the time of factory shipment.

FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS MICRO PHOTO-ELECTRIC SENSORS AREA SENSORS

LIGHT CURTAINS / SAFETY COMPONENTS

PRESSURE / FLOW SENSORS

INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS MEASURE-MENT SENSORS STATIC ELECTRICITY PREVENTION DEVICES LASER MARKERS

PLC HUMAN MACHINE INTERFACES ENERGY CONSUMPTION VISUALIZATION COMPONENTS

FA COMPONENTS MACHINE VISION SYSTEMS

UV CURING SYSTEMS

Selection Guide

## SPECIFICATIONS

#### Controller

Model No.		HD-T1C	
Applicable sensor head		HD-T1030	
Supply voltage Current consumption		24 V DC ±10 %     Ripple P-P 10 % or less       70 mA or less (Including sensor head)	
	Response time	0.5 ms or less (8 V/ms or more)	
	Resolution	30 µm 1.181 mil (Note 2)	
	Linearity	±1.0 % F.S. (at 28 mm 1.102 in sensing width of the sensing center) (Note 3)	
	Temperature characteristics	±0.1 % F.S./°C (at 24 ± 2 °C 75.2 ± 35.6 °F) (Note 3)	
Spa	n adjustment function	Span of the analog output voltage is adjusted. 15-turn endless adjuster	
Shif	t adjustment function	Offset of the analog output voltage is adjusted. 15-turn endless adjuster	
Warming-up period		30 min. or more	
	Pollution degree	3 (Industrial environment)	
D)	Protection	IP40 (IEC)	
tanc	Ambient temperature	0 to +40 °C +32 to +104 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
resistance	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH	
ntal	EMC	EN 61000-6-2, EN 61000-6-4	
nme	Voltage withstandability	1,000 V AC for one min. between all supply terminals connected together and enclosure	
Environmental	Insulation resistance	20 M $\Omega$ , or more, with 250 V DC megger between all supply terminals connected together and enclosure	
Ш	Vibration resistance	10 to 150 Hz frequency, 0.75 mm 0.030 in amplitude in X, Y and Z directions for two hours each	
	Shock resistance	490 m/s <sup>2</sup> acceleration (50 G approx.) in X, Y and Z directions for three times each	
Mate	erial	Enclosure: Heat-resistant ABS, Connector cover: Heat-resistant ABS, Adjuster cover: Polycarbonate	
Cab	le	0.22 mm <sup>2</sup> 3-core heat-resistant PVC cable, 0.3 m 0.984 ft long	
Cab	le extension	Extension up to total 3 m 9.843 ft is possible with 0.3 mm <sup>2</sup> , or more, heat-resistant PVC cable.	
Weight		Net weight: 85 g approx.	

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C +68 °F.

2) Resolution refers to the peak to peak distance conversion value of analog output (in the frequency band below 20 MHz).

3) This is the representative example of measurement with a combination of sensor head and controller.

## I/O CIRCUIT AND WIRING DIAGRAMS (Controller)

Wafe Detectior
Liquid Leak Detection
Liquid Leve Detection
Water Detection
Color Mark Detection
Hot Melt Glue Detection
Ultrasonio
Small / Slim Object Detection
Obstacle Detection
Other Products

M-DW1





Note: Analog output does not incorporate a short-circuit protection circuit. Do not connect it directly to a power supply or a capacity load.

Symbols ... D : Reverse supply polarity protection diode ZD: Surge absorption zener diode

#### **Terminal arrangement**



Terminal No.	Description		
1	+V		
2	0 V	Emitter side	
3	Emission pulse		
4	Shield		
(5)	Shield	Receiver side	
6	Light received signal		
(7)	0 V		
8	+V		

## PRECAUTIONS FOR PROPER USE

· Never use this product as a sensing device for personnel protection.



· In case of using sensing devices for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.

· Make sure to use the sensor head and the controller together as a set.

## Mounting

#### Sensor head

- · Mount the sensor head using 2 pcs. M4 hexagon-sockethead bolts (purchase separately) with a tightening torque of 0.5 N·m or less.
- · Do not remove the screws fixing the emitter / receiver and the mounting base. If removed, the output value will change.
- · Do not fix with the screws, using the mounting hole on the side of emitter / receiver.



## Controller

#### <In case of using DIN rail>

- ①Fit the front part of the mounting section of the unit on the 35 mm 1.378 in width DIN rail, pressing the stopper towards the arrow (the stopper is locked) shown in the right figure.
- <sup>(2)</sup>Press down the rear part of the mounting section of the unit on the 35 mm 1.378 in width DIN rail to fit it.
- \* For removal, insert a flat-bladed screwdriver into the groove of the stopper and pull the handle backwards.



## DIMENSIONS (Unit: mm in)



#### Refer to p.1458~ for general precautions.

#### <In case of using screws>

 Mount using M4 pan head screws with a tightening torque of 1.2 N·m or less.



#### Wiring

- · Analog output of controller does not incorporate a shortcircuit protection circuit. Do not connect it directly to a power supply or a capacity load.
- Care should be taken that static electricity is not applied to the connector during wiring. It may damage the product.
- Take care that wrong wiring will damage the product.
- Cable extension is possible up to total 3 m 9.843 ft with 0.3 mm<sup>2</sup>, or more, cable. Note that the cable length of the sensor head cannot be changed.
- · Do not apply stress such as forced bending and pulling to the cable joint.
- · Make sure to use an isolation transformer for the DC power supply. If an autotransformer (single winding transformer) is used, this product or the power supply may get damaged.
- In case a surge is generated in the used power supply. connect a surge absorber to the supply and absorb the surge.

## Others

- Do not use during the initial transient time (0.5 sec. approx.) after the power supply is switched on.
- This product outputs according to the amount of LED light received. Optical power varies between the center and the periphery of sensing range, and note that dimensional accuracy cannot be assured.
- · Do not allow any water, oil, fingerprints, etc., which may refract light, or dust, dirt, etc., which may block light, to stick to the emitting / receiving surfaces of the sensor head. In case they are present, wipe them with a clean, dust-free soft cloth or lens paper.
- If the sensing object is specular or transparent object, note that accurate measurement may not be possible.

The CAD data in the dimensions can be downloaded from our website.

HD-T1C Controller
0.472 (10) 0.472 (0.394) 0.354 <u>Shift adjuster</u> 0.354 <u>Shift adjuster</u> 0.3 m 0.984 ft long 0.3 m 0.984 ft long 0.3 m 0.984 ft long 0.3 m 0.984 ft long
21.5 0.846 0.236 Suitable for 35 mm 1.378 in width DIN rail
5 0.197 10 0.197 0.197 0.197 0.197 0.197 0.197 0.197 0.217 $2 \cdot \varphi 4.5 \ \varphi 0.177$ mounting holes 0.118 0.394

When the cover is removed



M-DW1

ł Connector for 47.3

7.5 Δ

sor head connection

M4 pan head screws LASER SENSORS (Purchase ) (separately.) рното ELECTRIC

MICRO PHOTO-ELECTRIC SENSORS AREA SENSORS

LIGHT CURTAINS / SAFETY

COMPONENTS

PRESSURE / FLOW

SENSORS

INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS

MEASURE

MENT SENSORS

STATIC ELECTRICITY PREVENTION

LASER MARKERS

DEVICES

PLC

HUMAN

ENERGY CONSUMPTIO VISUALIZATIO COMPONENTS

MACHINE INTERFACES

FA COMPONENTS

MACHINE

VISION SYSTEMS

UV CURING SYSTEMS

Selectio Guide

Wafer

Liquid Leak

Liquid Level

Water Detection

FIBER SENSORS